	8 7 6 5	5 4 3 2 1 NOTES: 1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP) GLASS-FILLED, UISAV-0 TERMINALS - HIGH PERFORMANCE COPPER ALLOY 1 2. FINISH: 30ulh GOLD IN CONTACT AREA. SELECTIVE TIN ON POET FAILS. NICKEL OVERALL. 3. REFER TO MOLEX PRODUCT SPECIFICATION PS-171320-999 FOR PERFORMANCE SPECIFICATIONS. 3. REFER TO MOLE Y PRODUCT SPECIFICATION SOLUTEMENTS OF MOLEX COSMETIC SPEC 954549-002. 5. PRODUCT WILL BE PACKAGED PER PK-7888-313. 6. SEE STEM FOLE PATTERN DIMENSIONS. 7. MATES WITH IMPEL PS SERIES NUMBER 171745. 6. 8. REFER TO IMPEL PCB ROUTING GUIDE AS-171320-990 FOR ANTIPAD, ROUTING RECOMMENDATIONS, AND ADDITIONAL PCB INFORMATION 9. WHEN STACKING MODULES END TO END, THE MINIMUM COLUMN TO COLUMN HOLE SPACING IS 2.65mm. 0 10. WHEN USING THE SUPPLIED 2:32 THREAD FORMING SCREW (737264000), THE MAXIMUM RECOMMENDED BOARD THICKNESS IS 2.4mm. F
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	MATERIAL NUMBER	NUMBER OF COLUMNS	NUMBER OF DIFF PAIR	DIM "A"	DIM "B"			
Н	171750-5038	8	16	23.40 MAX	13.30	_		
	171750-5020	10	20	27.20 MAX	17.10			
	171750-5022	12	24	31.00 MAX	20.90			
	171750-5026	16	32	38.60 MAX	28.50			
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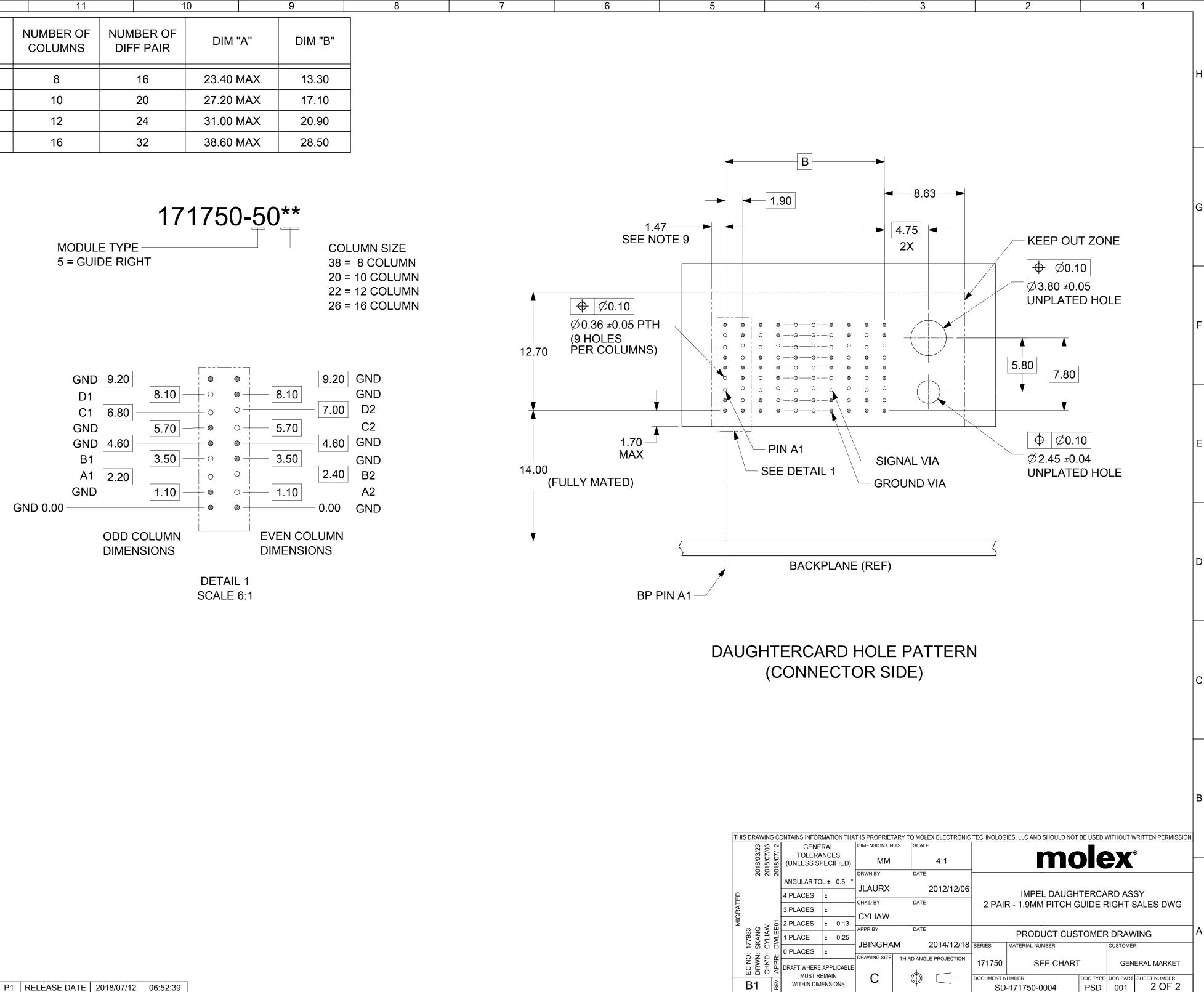
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